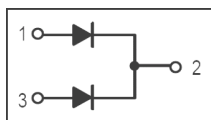


/ Descriptions

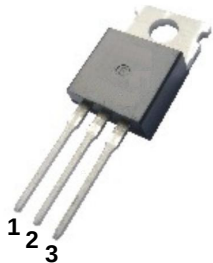
/ Features

/ Applications

/ Equivalent Circuit

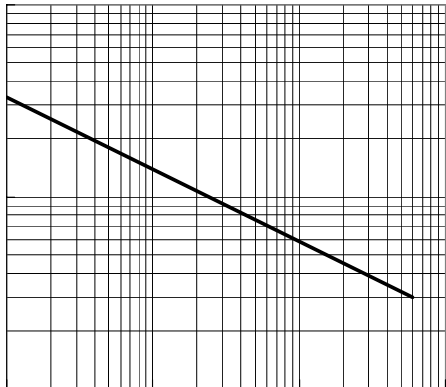
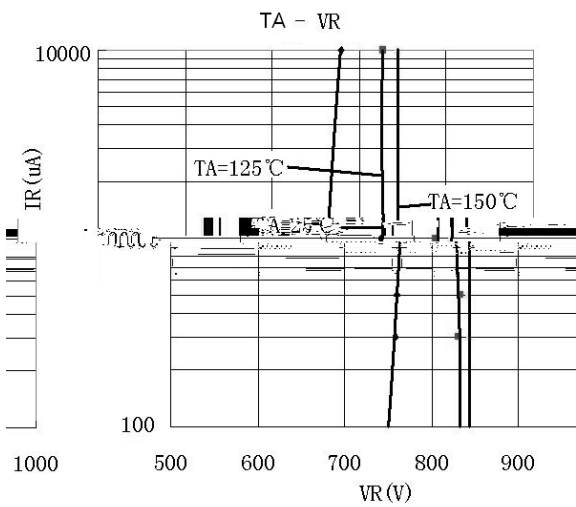
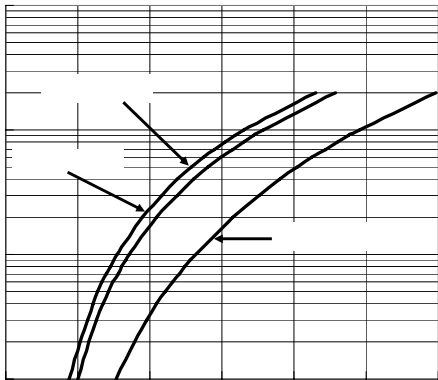
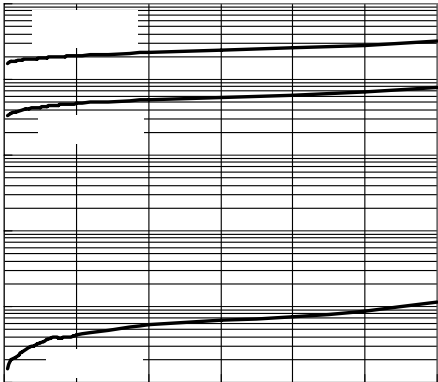
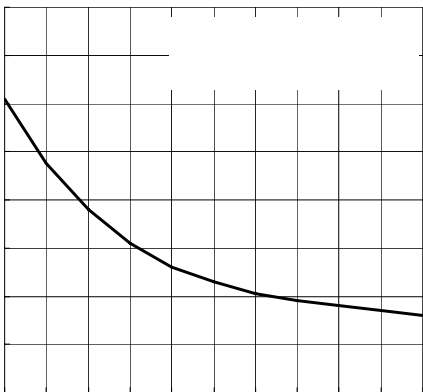
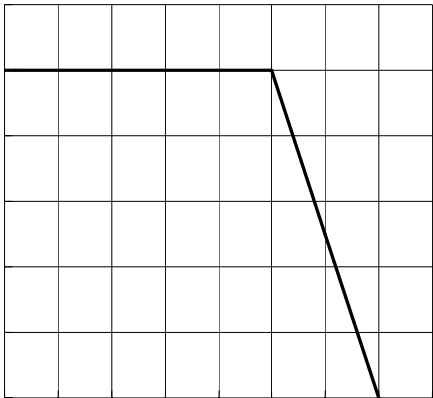


/ Pinning

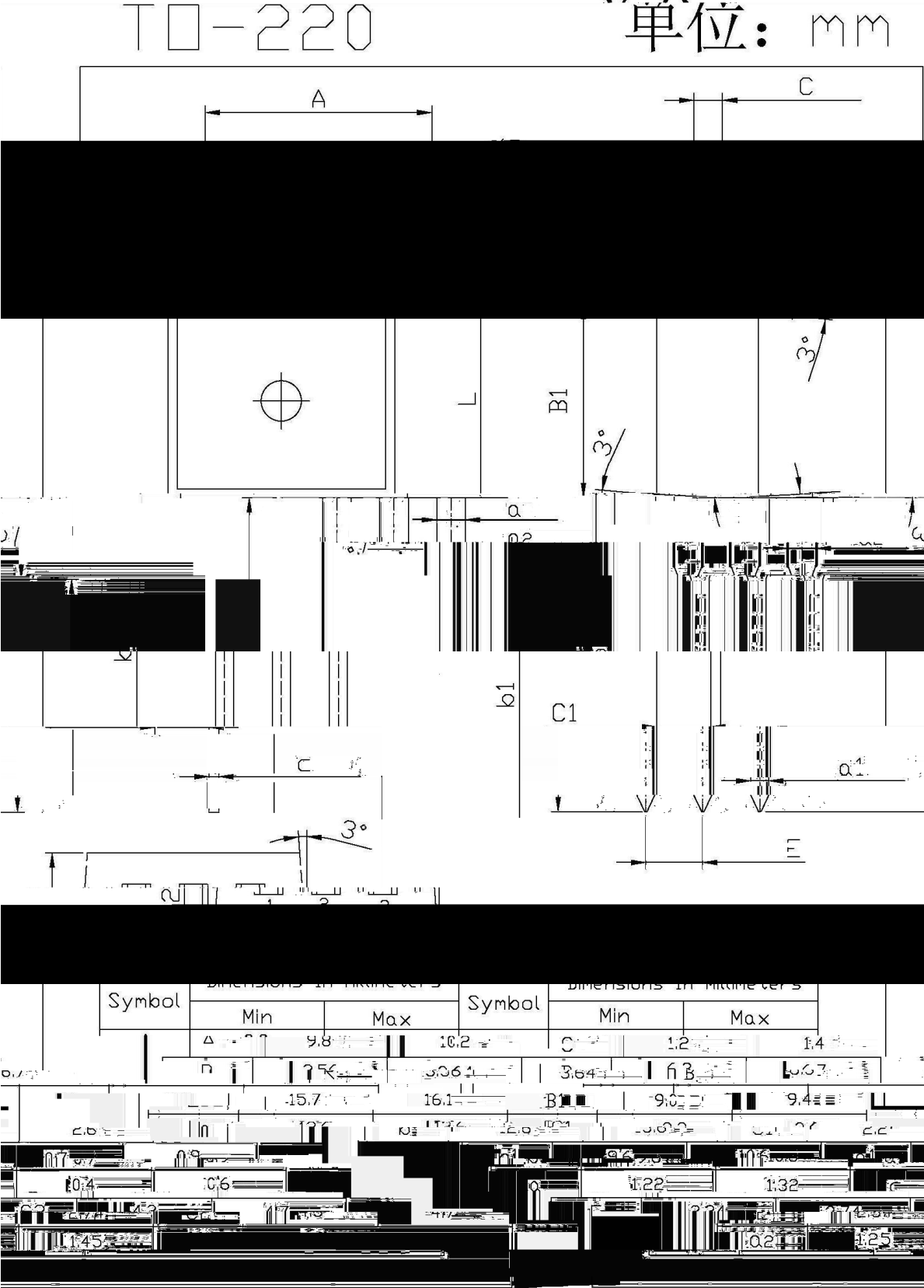


/ h_{FE} Classifications & Marking

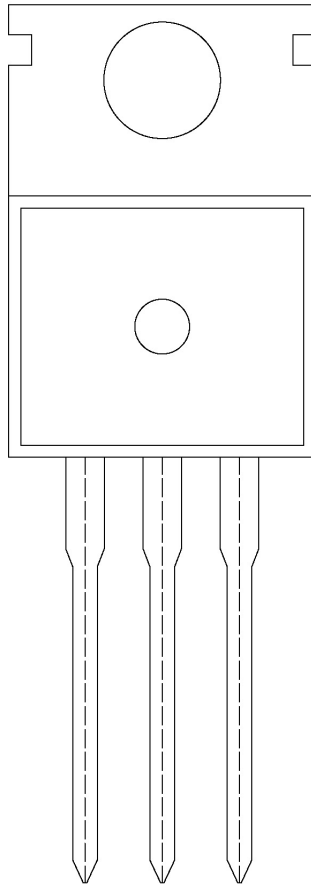
/ Electrical Characteristic Curve



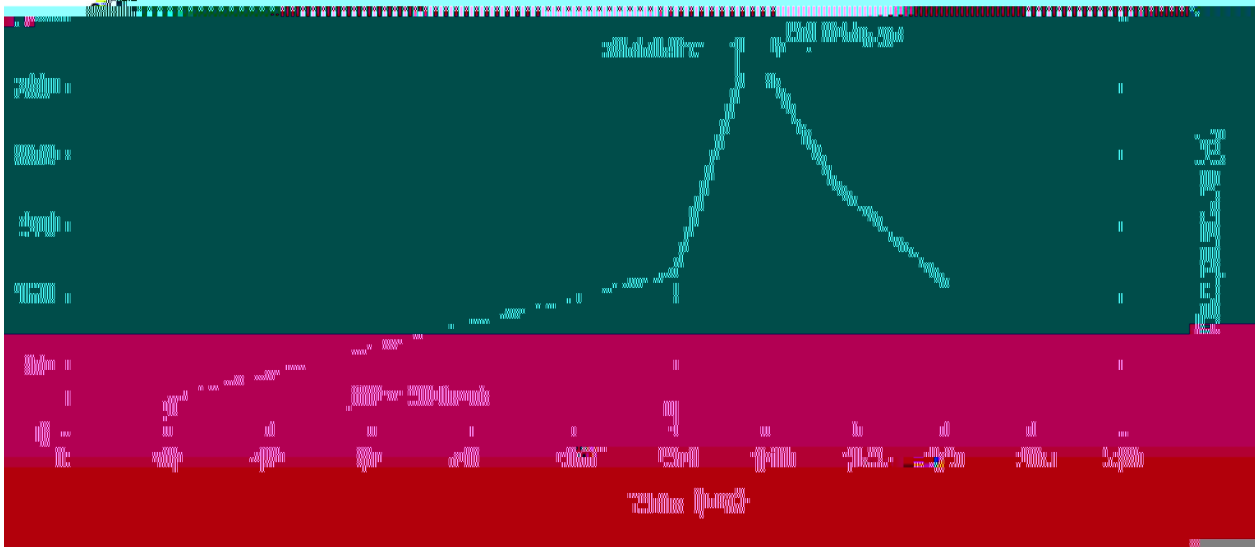
/ Package Dimensions



/ Marking Instructions



() / Temperature Profile for Dip Soldering(Pb-Free)



/ Resistance to Soldering Heat Test Conditions

/ Packaging SPEC.

/ Notices